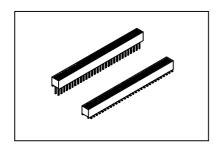
# **GXCON**



- Features:
  \* Choice of through-hole and surface mount.
- \* Low profile 4.57mm(0.180\*).
- \* Mates with 0.46mm(0.018") square pin.
  \* Choice of two different dip length.

### Material:

Housing: High temperature housing withstands IR and VPR soldering methods.

Contacts: Phosphor Bronze. Plating: Gold plated over nickel.

Tin plated over nickel.

## **Electrical Characteristics:**

Current Rating: 1 AMP.

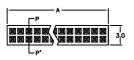
Insulator Resistance: 5000MΩmin. at DC 500V. Contact Resistance: 20mΩmax. at DC 100mA. Operating Temperature:  $-65^{\circ}\text{C} \sim +125^{\circ}\text{C}$ .

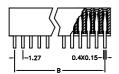
Max Processing Temperature: 230°C for 30~60 seconds.

Mechanical Characteristics:

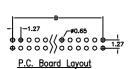
Insertion Force:140g avg.(0.46mm dia. pin)

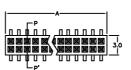
Withdrawal Force: 114g avg. (0.46mm dia. pin)

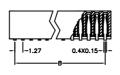




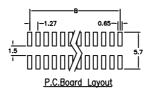












| х         | 1               | 2                |  |  |  |
|-----------|-----------------|------------------|--|--|--|
| Length    | 3.05            | 1.91             |  |  |  |
| Position  | 6 Thru 100      |                  |  |  |  |
| Dimension | 6 Inru 100      |                  |  |  |  |
| Α         | 1.27 X No. of F | ositions /2+0.4  |  |  |  |
| В         | 1.27 X No. of P | ositions /2-1.27 |  |  |  |

# Ordering information

| <u>PS22-</u> 2 | <u>50</u>    | <u>1</u>   | <u>.</u>              | <u>1</u>         | 1          |
|----------------|--------------|------------|-----------------------|------------------|------------|
| Series Do      | uble Row No. | of 3:      | Selective Gold Plated | 1: Straight      | *1: 3.05mm |
|                | Pin          | Per Row 1: | Gold Plated           | 3: Surface Mount | *2: 1.91mm |